

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Applicant(s): Tonapi, et al. Docket: 136343 (1306-24)
Serial No.: 10/647,680 Examiner: Not Yet Known
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For: THIN BOND-LINE SILICONE Dated: February 5, 2004
ADHESIVE COMPOSITION AND
METHOD FOR PREPARING THE SAME

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CHANGE OF CORRESPONDENCE ADDRESS IN APPLICATION

Please send all future correspondence for this application to:

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Respectfully submitted,

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope, addressed to the: Assistant Commissioner for Patents, Washington, D.C. 20231 on February 5, 2004.

Dated: February 5, 2004

Jennifer Vitale